

# **High Intensity SMD LED**

Color	Туре	Technology	Angle of Half Intensity
			±φ
White	TLMW3145	InGaN / YAG on SiC	60°

#### **Description**

This device have been designed to meet the increasing demand for white SMD LED.

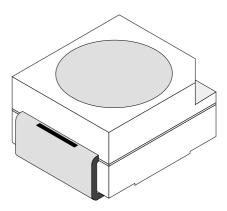
The package of the TLMW3145 is the P–LCC–2 (equivalent to a size B tantalum capacitor).

It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled with a mixture of epoxy and YAG phoshor.

The YAG phoshor converts the blue emission partially to yellow, which mixes with the remaining blue to give white.



- High efficient InGaN technology
- Chromaticity Coordinate categorized according to CIE1931 per packing unit
- Luminous intensity ratio in one packing unit  $I_{Vmax}/I_{Vmin} \le 1.75$
- Typical color temperature 5500K
- ESD class 1
- EIA and ICE standard package
- Compatible with infrared, vapor phase and wave solder processes according to CECC
- Available in 8 mm tape reel



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#### **Applications**

Automotive: backlighting in dashboards and switches Telecommunication: indicator and backlighting in telephone and fax

Backlighting for audio and video equipment

Backlighting in office equipment

Indoor and outdoor message boards

Flat backlight for LCDs, switches and symbols

Illumination purposes, alternative to incandescent lamps

General use

### **Absolute Maximum Ratings**

 $T_{amb} = 25$ °C, unless otherwise specified

#### **TLMW3145**

Parameter	Test Conditions	Symbol	Value	Unit
Reverse voltage		$V_{R}$	5	V
DC forward current	T <sub>amb</sub> ≤ 70°C	l <sub>F</sub>	20	mA
Surge forward current	t <sub>p</sub> ≤ 10 μs	$I_{FSM}$	0.1	Α
Power dissipation	T <sub>amb</sub> ≤ 70°C	$P_V$	85	mW
Junction temperature		T <sub>i</sub>	100	°C
Operating temperature range		T <sub>amb</sub>	-40 to +100	°C
Storage temperature range		$T_{stg}$	-40 to +100	°C
Soldering temperature	t ≤ 5 s	T <sub>sd</sub>	260	°C
Thermal resistance junction/ambient	mounted on PC board (pad size > 16 mm <sup>2</sup> )	R <sub>thJA</sub>	350	K/W

## **TLMW3145**

## Vishay Semiconductors



### **Optical and Electrical Characteristics**

 $T_{amb} = 25$ °C, unless otherwise specified

White (TLMW3145)

Parameter	Test Conditions	Туре	Symbol	Min	Тур	Max	Unit
Luminous intensity 1)	I <sub>F</sub> = 10 mA	TLMW3145	Ι <sub>V</sub>	40	65	100	mcd
Chromaticity coordinate x acc. to CIE 1931	10 mA	TI MM/24 4E	х	0.305		0.375	
Chromaticity coordinate y acc. to CIE 1931	- I <sub>F</sub> = 10 mA	TLMW3145	У	0.260		0.440	
Angle of half intensity	I <sub>F</sub> = 10 mA		φ		±60		deg
Forward voltage	I <sub>F</sub> = 10 mA		V <sub>F</sub>		3.5	4.0	V
Reverse voltage	I <sub>R</sub> = 10 μA		V <sub>R</sub>	5			V
Temperature coefficient of V <sub>F</sub>	I <sub>F</sub> = 20 mA		TC <sub>VF</sub>		- 4		mV/K
Temperature coefficient of I <sub>V</sub>	I <sub>F</sub> = 20 mA		TC <sub>IV</sub>		- 0.5		%/K
1) in one Packing Unit I <sub>V</sub> Min./ I <sub>V</sub> Max. ≤ 1.75							

## **Chromaticity Coordinate Classification**

Group	X		Υ		
	min	max	min	max	
4	0.305	0.350	0.260	0.390	
5	0.330	0.375	0.310	0.440	

## **Luminous Intensity Classification**

Group	Luminous Intensity (mcd)		
	min	max	
UA	40	70	
UB	58	100	



# **Typical Characteristics** ( $T_{amb} = 25^{\circ}C$ , unless otherwise specified)

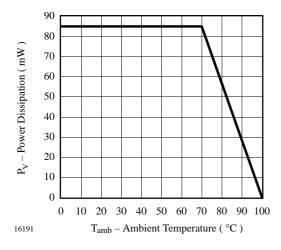


Figure 1 Power Dissipation vs. Ambient Temperature

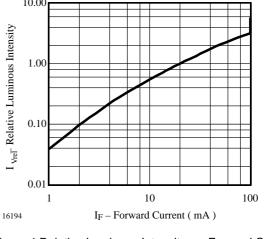


Figure 4 Relative Luminous Intensity vs. Forward Current

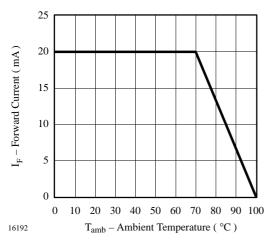


Figure 2 Forward Current vs. Ambient Temperature

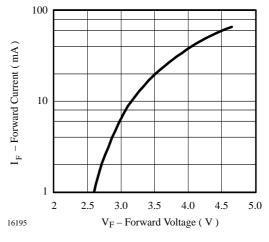


Figure 5 Forward Current vs. Forward Voltage

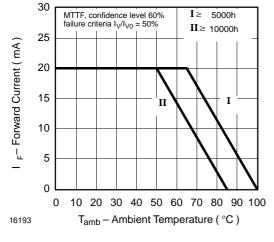


Figure 3 Forward Current vs. Ambient Temperature

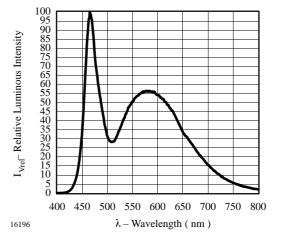


Figure 6 Relative Luminous Intensity vs. Wavelength



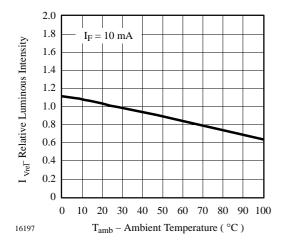


Figure 7 Rel. Luminous Intensity vs. Ambient Temperature

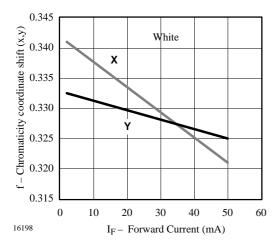


Figure 8 Chromaticity Coordinate Shift vs. Forward Current

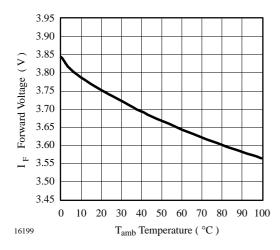


Figure 9 Forward Voltage vs. Ambient Temperature

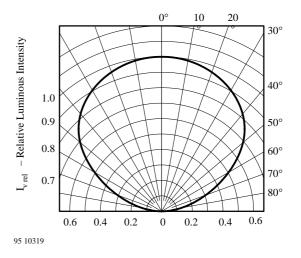


Figure 10 Rel. Luminous Intensity vs. Angular Displacement

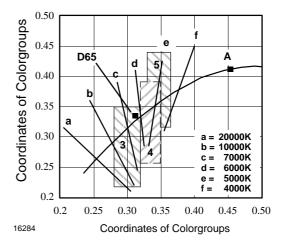
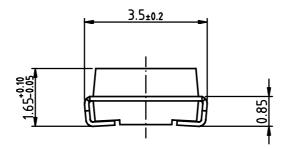
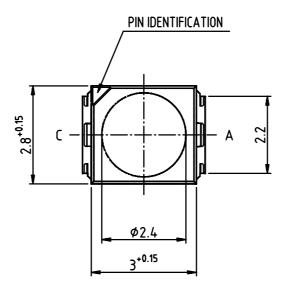


Figure 11 Coordinates of Colorgroups



#### **Dimensions in mm**

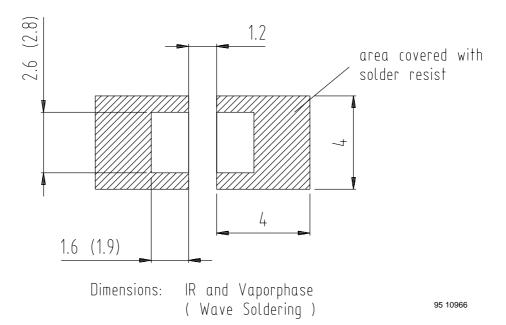






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## **PCB** Layout in mm



#### **TLMW3145**

#### **Vishay Semiconductors**



#### **Ozone Depleting Substances Policy Statement**

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**Vishay Semiconductor GmbH** has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423